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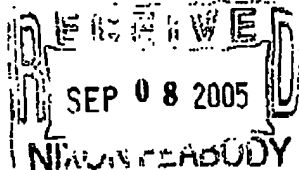
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APPL. NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/529,172	03/24/2005	2812	3810	743421-82	5	35	4

22204  
NIXON PEABODY, LLP  
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WASHINGTON, DC 20004-2128

CONFIRMATION NO. 4216

FILING RECEIPT



\*OC000000016896054\*

Date Mailed: 09/02/2005

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**Applicant(s)**Masuo Kondo, Osaka, JAPAN;  
Fumiaki Kikui, Osaka, JAPAN;**Assignment For Published Patent Application**

Neomax Materials Co., Ltd., Suita-shi, Osaka, JAPAN

**Power of Attorney:** The patent practitioners associated with Customer Number 22204.**Domestic Priority data as claimed by applicant**

This application is a 371 of PCT/JP03/12183 09/24/2003

**Foreign Applications**JAPAN 2003-283301 09/27/2002  
JAPAN 2002-291187 10/03/2002**Projected Publication Date:** 12/08/2005**Non-Publication Request:** No**Early Publication Request:** No9/8/05 Docketed  
By SOW / hch  
Nixon Peabody, LLP

Title

**SOLDER BALL METHOD OF MAKING THE SAME, AND METHOD OF MAKING**  
~~Solder-coated ball and method for manufacture thereof, and method for forming semiconductor interconnecting structure~~  
**SEMICONDUCTOR INTERCONNECT STRUCTURE**

Preliminary Class

438

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